

## Surface mount fast recovery rectifiers

**Features**

- Low profile package
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering:  
260°C/10 seconds at terminals
- Component in accordance to  
RoHS 2011/65/EU and WEEE 2002/96/EC



1.Cathode  
2.Anode

**Mechanical Data**

- **Case:** SOD-323  
Molding compound meets  
UL 94 V-0 flammability rating
- **Terminals:** Solder plated, solderable per  
MIL-STD-750, Method 2026
- **Polarity:** Laser band denotes cathode end

**Major Ratings and Characteristics**

$I_{F(AV)}$	1.0A
$V_{RRM}$	50V to 1000V
$I_{FSM}$	25A
$t_{rr}$	150nS, 250nS, 500nS
$V_F$	1.3V
$T_{Jmax.}$	150°C

**Maximum Ratings & Thermal Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

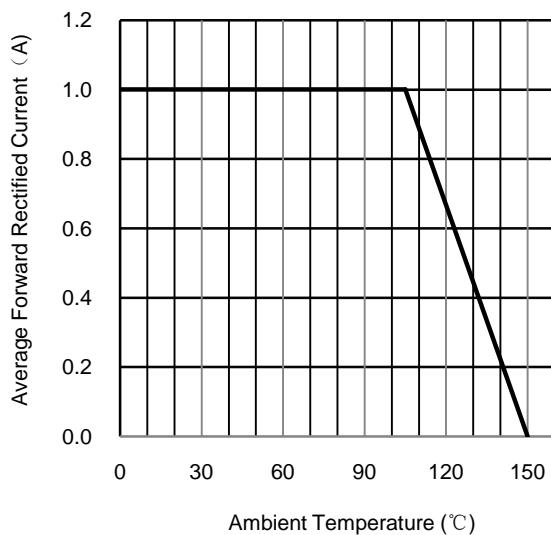
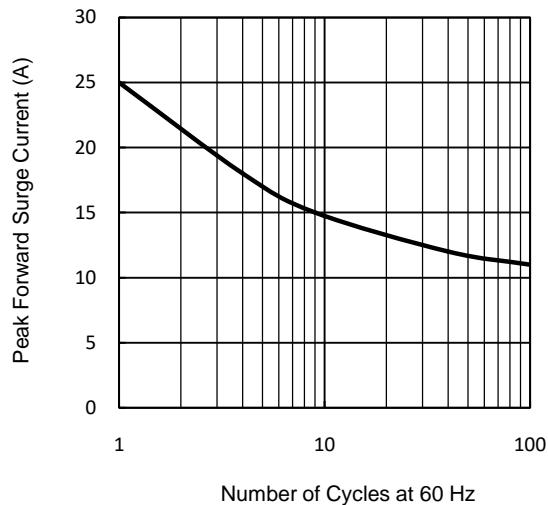
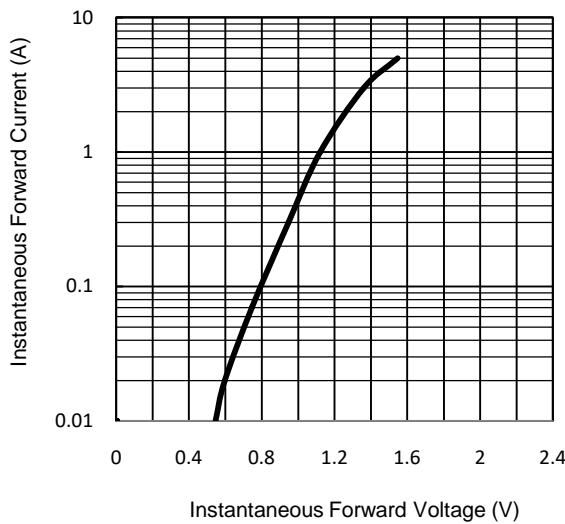
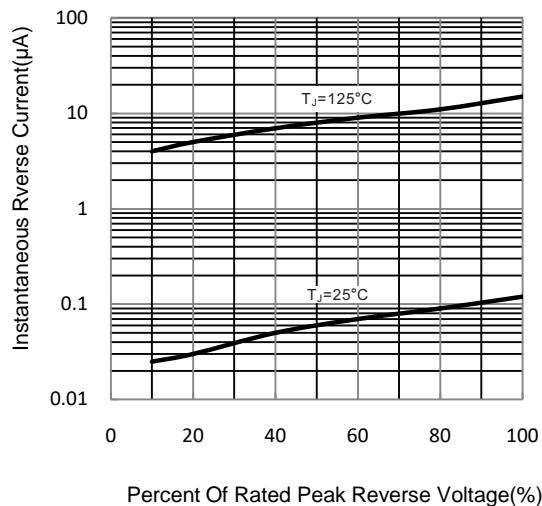
Item	Symbol	FR10 1WS	FR10 2WS	FR10 3WS	FR10 4WS	FR10 5WS	FR10 6WS	FR10 7WS	Unit
<b>Marking code</b>		F1	F2	F3	F4	F5	F6	F7	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L=105^\circ\text{C}$	$I_{F(AV)}$	1.0						A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	25						A	
Operating and storage temperature range	$T_J, T_{STG}$	-55 to +150						°C	
Thermal resistance from junction to lead <sup>(1)</sup>	$R_{\theta JL}$	35						°C/W	

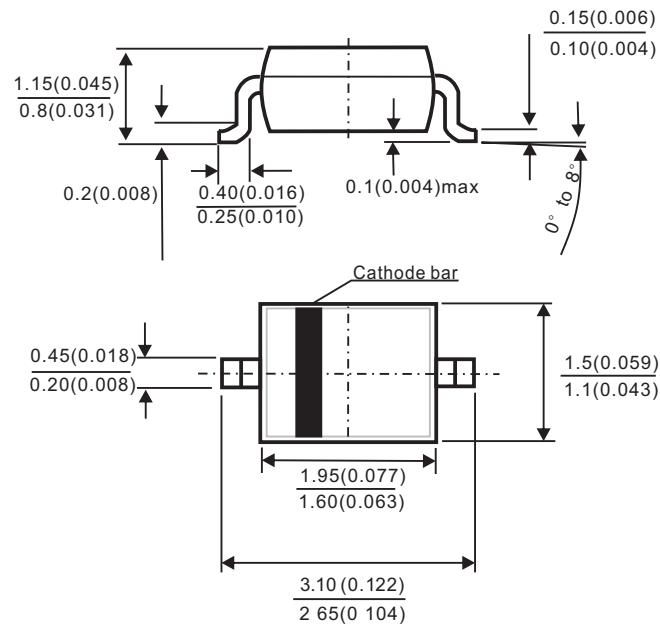
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Item	Test conditions	Symbol	FR101WS~FR104WS	FR105WS	FR106WS~FR107WS	Unit
Instantaneous forward voltage	$I_F=1.0\text{A}^{(2)}$	$V_F$	1.3			V
Maximum reverse current	$V_R=V_{DC}$	$I_R$	$T_J=25^\circ\text{C}$			$\mu\text{A}$
			$T_J=125^\circ\text{C}$			
Reverse recovery time	$I_F=0.5\text{A}$ $I_R=1.0\text{A}, I_{rr}=0.25\text{A}$	$t_{rr}$	150	250	500	nS

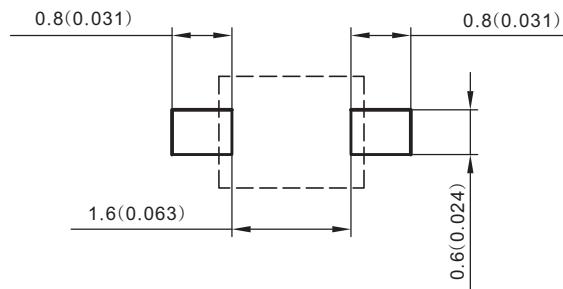
Note1: Mounted on PCB with 0.2x0.2" (5.0mmx5.0mm) copper pad areas

2.Pulsetest: 300μs pulse width, 1% duty

**Fig.1 Forward Current Derating Curve****Fig.2 Maximum Non-Repetitive Peak Forward Surge Current****Fig.3 Typical Instantaneous Forward Characteristics****Fig.4 Typical Reverse Characteristics**

**SOD-323**

Footprint recommendation:



Package dimensions in millimeters (inches)